HEITECH PADU BERHAD
[Registration No. 199701036234 (451734-A)]
(Incorporated in Malaysia)

8 June 2026

To the Shareholders of HEITECH PADU BERHAD

ERRATA TO THE ANNUAL REPORT 2025 OF HEITECH PADU BERHAD ("THE COMPANY")

Reference is made to the Company's Annual Report 2025 submitted to Bursa Malaysia Securities Berhad on 30 April 2026.

The following disclosures in the Annual Report 2025 shall be amended by this Errata and corrected as shown below:

1. **Page 164 of the Annual Report 2025 in relation to the Issue of Shares and Debentures in the Directors' Report**

   During the financial year, the Company increased its issued and paid up share capital through the issuance of:

   (a) 23,800,000 new ordinary shares at an issue price of RM1.55 per ordinary share via private placement for a total cash consideration of RM36,890,000 for working capital purposes; and

   (b) 27,837,000 new ordinary shares through a bonus issue on the basis of one new ordinary share for every four existing ordinary shares held in the Company.

2. **Page 177 of the Annual Report 2025 in relation to the Statement of Profit or Loss and Other Comprehensive Income**

   Earnings per share attributable to owners of the parent (sen per share):

	Group	
	2025	**2024**
Basic and diluted	15.52	6.32

3. Page 203 of the Annual Report 2025 in relation to Note 13 – Earning per Share

The following tables reflect the profit and share data used in the computation of basic and diluted earning per share:

	Group	
	2025	2024
	RM'000	RM'000
Number of ordinary shares in issue at the beginning of the financial year ('000)	111,348	101,225
Effects of issuance of share capital ('000)	20,789	4,919
Weighted average number of ordinary shares in issue for basic and diluted earnings per share computation ('000)	132,137	106,144
Basic and diluted earnings per share (sen per share)	15.52	6.32

4. Page 231 of the Annual Report 2025 in relation to Note 30 – Share Capital

	Group and Company			
	Number of ordinary shares			
	2025	2024	2025	2024
	'000	'000	RM'000	RM'000
Issued and fully paid up with no par value:				
At 1 January	111,348	101,225	136,652	117,751
Issued during the year	51,637	10,123	36,890	18,901
At 31 December	162,985	111,348	173,542	136,652

During the financial year, the Company increased its issued and paid up share capital through the issuance of:

(a) 23,800,000 new ordinary shares at an issue price of RM1.55 per ordinary share via private placement for a total cash consideration of RM36,890,000 for working capital purposes; and

(b) 27,837,000 new ordinary shares through a bonus issue on the basis of one new ordinary share for every four existing ordinary shares held in the Company.

In the previous year, the issued and paid up share capital of the Company was increased from RM117,751,000 to RM136,652,000 by way of issuance of 10,122,520 ordinary shares, at an issue price ranging from RM1.73 to RM2.01 per ordinary share via private placement for a total cash consideration of RM18,901,000 for working capital purposes.

Save for the abovementioned amendments, information in the Statements of Profit or Loss and Other Comprehensive Income, Statements of Financial Position and Statement of Changes in Equity and other information in the Company's Annual Report 2025 shall remain valid and unchanged.

We regret for any inconvenienced caused.

Yours faithfully
HEITECH PADU BERHAD

MOHD NOR AZAM MOHD SALLEH
Group Company Secretary
(MAICSA 7028137) (SSM PC NO. 201908002015)